

## RELIABILITY MONITOR SAMPLING PLAN

<u>PRODUCT</u>	<u>FAMILY</u>	<u>TECHNOLOGY</u>	<u>ASSEMBLY/ALT</u>	<u>PACKAGE</u>	<u>QUANTITY</u>	<u>FREQUENCY</u>
1991	AUTO. ID.	Battery	Dallas	Touch Can	100	QUARTERLY
2401	AUTO. ID.	0.8 Ox Ni	Carsem	03 TO92	250	QUARTERLY
2502	AUTO. ID.	0.8 Ox Ni EPROM	Carsem / Anam, K	08 SOIC150	250	QUARTERLY
2502	AUTO. ID.	0.8 Ox Ni EPROM	Carsem	06 TSOC	160	QUARTERLY
1210	BAT. BACK.	3.0 Ox Ni	Anam, K / Hyundai	16 SOIC	250	QUARTERLY
1232	CPU SUP.	3.0 Ox Ni	Hyundai / Anam, K	16 SOIC	250	QUARTERLY
1233	CPU SUP.	1.2 Ni	Carsem	03 SOT223	250	QUARTERLY
1000	DELAY	1.2 Ni	Omedata	08 PDIP	250	QUARTERLY
1267	DIG. POT.	1.2 Ox Ni	Anam, PI	20 TSSOP	250	QUARTERLY
1669	DIG. POT.	1.2 Ox Ni EEPROM	Omedata	08 SOIC208	250	QUARTERLY
232A	DRIVER	5.0 Ox Ni	Omedata	16 PDIP	250	QUARTERLY
5000T	MICRO	Battery	Dallas	40 Module	50	QUARTERLY
5002	MICRO	1.2 Ox Ni	Carsem / Anam, K	80 PQFP	215	QUARTERLY
80C320	MICRO	0.8 Ox Ni	Anam, PI	40 PDIP	250	QUARTERLY
1225	NV. MEMORY	Battery	Dallas	28 Module	215	QUARTERLY
1230	NV. MEMORY	Battery	Dallas	28 Module	215	QUARTERLY
1230	NV. MEMORY	Battery	Dallas	34 LPM	250	QUARTERLY
2250 / 2290	SipStik	Battery	Dallas	PCB	33	QUARTERLY/ALT
21S07A	TELECOM	0.8 Ni	Carsem / Anam, K	20 TSSOP	250	QUARTERLY
2108	TELECOM	5.0 Ni	Anam, K	24 SOIC	250	QUARTERLY
2153	TELECOM	0.8 Ox Ni	Anam, K	44 PLCC	250	QUARTERLY
2165 / 2175	TELECOM	1.2 Ox / 2.0 Ox	Hyundai / Anam, K	24 PDIP / 16 SOIC	250	QUARTERLY/ALT
2180A / 2181A	TELECOM	2.0 Ox	Anam, K	44 PLCC	250	QUARTERLY/ALT
1620	THERMAL MGR.	1.2 Ox Ni EEPROM	Omedata / NSEB	08 SOIC208	250	QUARTERLY
1621	THERMAL MGR.	0.8 Ox Ni EEPROM	Anam, K / Carsem	08 SOIC150	250	QUARTERLY
12887	TIME	Battery	Dallas	24 Module	210	QUARTERLY
1302	TIME	0.8 Ox Ni (2 MTL)	Hyundai / Anam, K	08 SOIC150	250	QUARTERLY
1315	TIME	0.8 Ox Ni (2 MTL)	Anam, PI	16 PDIP	250	QUARTERLY
1643	TIME	Battery	Dallas	28 Module	250	QUARTERLY
17485	TIME	0.8 Ox Ni (2 MTL)	Anam, K	24 SOIC	250	QUARTERLY

Table 1